

SS26

Schottky Barrier Rectifiers



Voltage: 60 Volts

Current: 2 A

Package: SMA

Features

- NH'S Plane Schottky Barrier Chip Technology
- Low Forward Voltage Drop For High Efficiency
- Low Power Loss For High Reliability
- High Frequency Switching Speed

Mechanical Data

- **Case:** Molded With UL-94 ClassV-0 Recognized, RoHS-Compliant
- **Polarity:** Look At The Diagram And Polarity On The Right
- **Terminals:** Tin Plated Leads,Solderable Per J-STD-002 And JESD22-B102

Typical Applications

- Switch Mode Power Supplies (SMPS)
- Fast Chargers
- LED Driver And Monitor Lighting
- Automotive Electronics And Charging Posts

Diagram:



Polarity:



Single Phase,Half Wave,60Hz,Resistive Or Inductive Load.For Capacitive Load,Derate Current By 20%

Maximum Ratings (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	Ratings	Unit
Maximum Repetitive Peak Reverse Voltage		V_{RRM}	60	V
Maximum RMS Voltag		V_{RMS}	42	V
Maximum DC Blocking Voltage		V_{DC}	60	V
Maximum Average Forward Rectified Current		$I_{F(AV)}$	2	A
Peak Forward Surge Current	8.3ms Single Half Sine-wave Superimposed On Rate Load	I_{FSM}	50	A
Current Squared Time	$t < 8.3ms$	I^2t	10.4	A ² sec

Electrical Characteristics (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	Ratings			Unit
			Min.	Typ.	Max.	
Instaneous Forward Voltage Per Diode	Ta=25°C	V_F	--	0.59	0.65	V
	Ta=110°C IF=2A		--	0.55	0.61	
Maximum DC Reverse Current at Rated DC Blocking Voltage	Ta=25°C , $V_R=V_{RRM}$	I_{RRM}	--	2	50	uA
	Ta=125°C , $V_R=V_{RRM}*80\%$		--	2	5	
Typical Junction Capacitance	4 V,1MHz	C_J	--	100	--	pF

Thermal Characteristics (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	Ratings			Unit
Operating Junction Temperature Range		T _J	-55	to	150	°C
Storage Temperature Range		T _{STD}	-55	to	150	
Thermal Resistance Junction To Ambient With Steady-State	Still Air Environment With Ta=25°C	R _{θJA}	75			°C/W
Thermal Resistance Junction-Case With Steady-State	Device Mounted On 1 in2 FR-4 Board With 2oz. Copper	R _{θJC}	22			

Notes: 1.Pulse Test: 300 Us Pulse Width,1% Duty Cycle

Typical Characteristics Curves

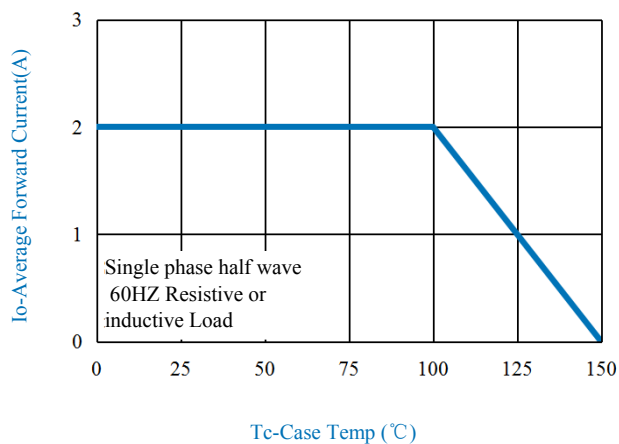


Fig.1-Forward Current Derating Curve

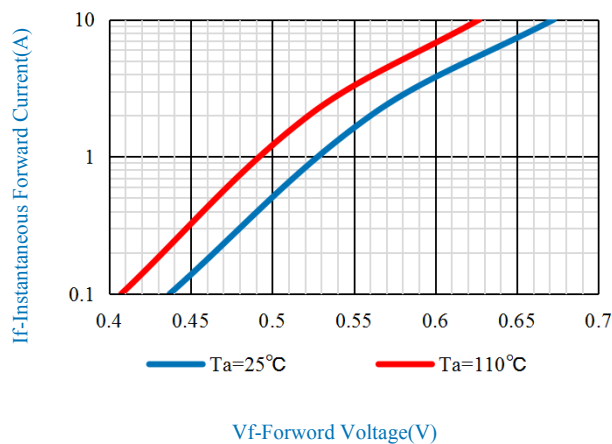


Fig.2-Typical Instantaneous Forward

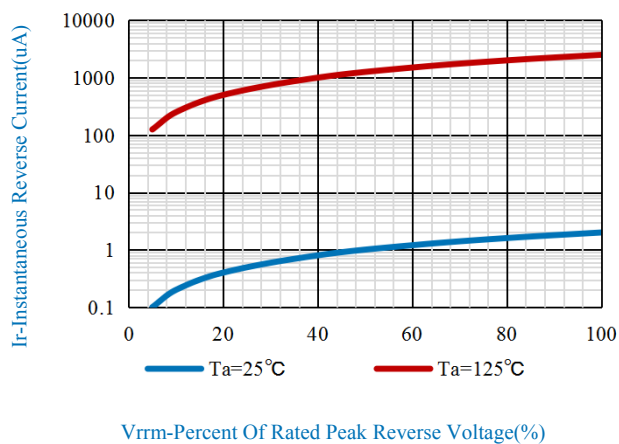


Fig.3-Typical Reverse Characteristics

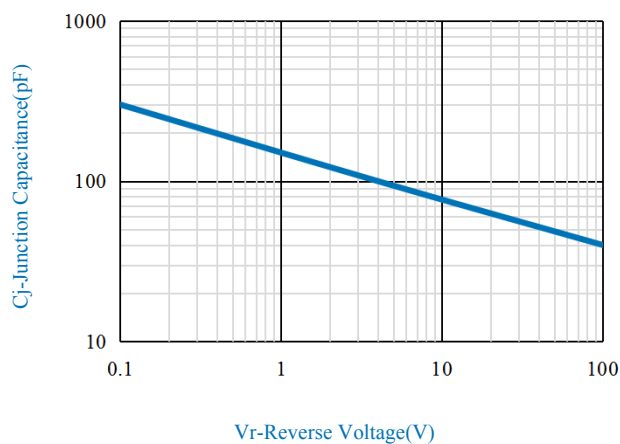


Fig.4-Typical Junction Capacitance

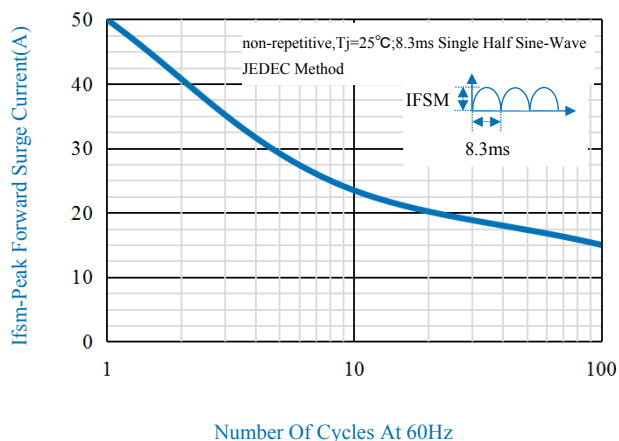


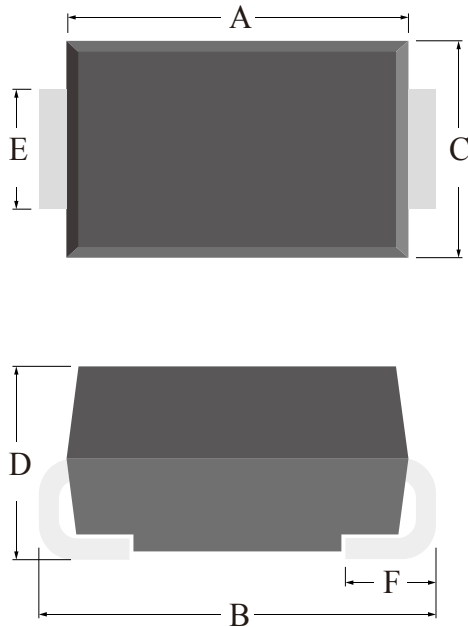
Fig.5-Max. Non-Repetitive Surge Current

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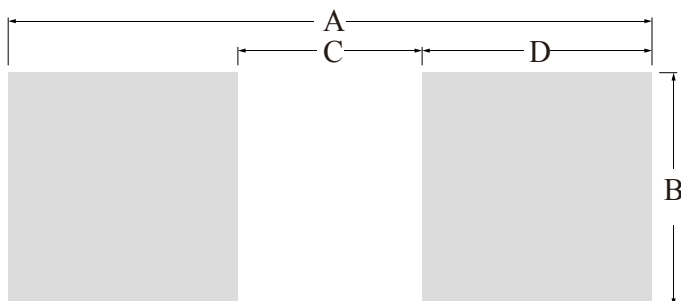
OUTLINE DRAWINGS



SMA

OUTLINE DIMENSIONS						
Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.00	-	4.60	0.1575	-	1.8110
B	4.70	-	5.28	1.8504	-	2.0787
C	2.40	-	2.85	0.9449	-	1.1220
D	1.90	-	2.58	0.7480	-	1.0157
E	1.30	-	1.60	0.5118	-	0.6299
F	0.76	-	1.52	0.2992	-	0.5984

RECOMMEDND LAYOUT DRAWINGS



SMA

OUTLINE DIMENSIONS						
Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	-	5.80	-	-	2.2835	-
B	-	2.06	-	-	0.8110	-
C	-	1.66	-	-	0.6535	-
D	-	2.07	-	-	0.8150	-

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MARKING



MARKING INSTRUCTION

NH=Niuhan Trademark

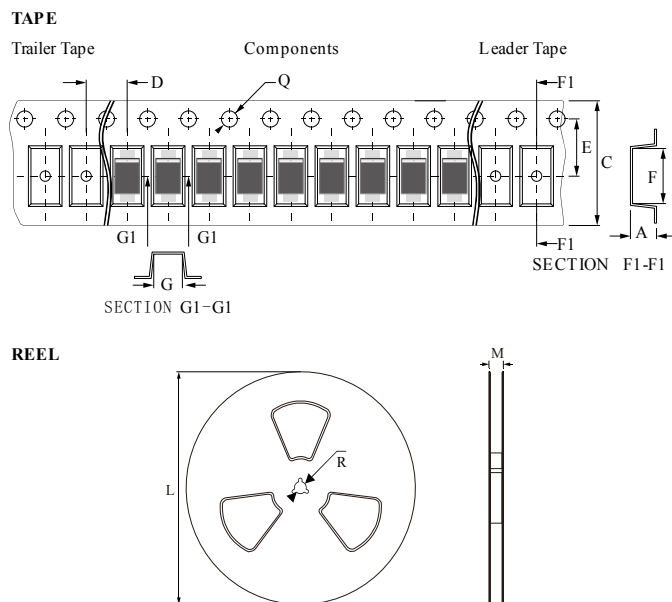
FF=Product Line Code,According To Actual Changes

YWW=Date Code,According To Actual Changes

SS26=Model

White band denotes cathode

PACKAGING



SMA

OUTLINE DIMENSIONS						
Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
TAPE						
A	2.45	-	2.65	0.0965	-	0.1043
C	11.70	-	12.30	0.4606	-	0.4843
D	3.80	-	4.20	0.1496	-	0.1654
E	5.30	-	5.70	0.2087	-	0.2244
F	5.13	-	5.53	0.2020	-	0.2177
G	2.69	-	2.89	0.1059	-	0.1138
Q Φ	1.40	-	1.60	0.0551	-	0.0630
REEL						
L	328.00	-	332.00	12.913	-	13.071
R	12.00	-	14.00	0.4724	-	0.5512
M	15.00	-	17.00	0.5906	-	0.6693

PACKING INFORMATION

Package Type	Package Code	Product Weight Approx(g/Pcs)	Package Method	Quantity (Pcs/Min. Pack.)	Quantity (Pcs/Inner Box)	Quantity (Pcs/Carton)
SMA	P1	0.063	13" Reel	5000	10000	80000
SMA	P2	0.063	13" Reel	5000	10000	100000

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Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

Recommended temperature profile for IR reflow

	Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
	Average ramp-up rate (T _{smax} to T _p)	3°C/second max.	3°C/second max.
	Preheat-Temperature Min (T _S min) -Temperature Max (T _S max) -Time(ts min to ts max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
	Time maintained above: -Temperature (T _L) - Time (t _L)	183°C 60-150 seconds	217°C 60-150 seconds
	Peak Temperature(T _P)	240 +0/-5 °C	260 +0/-5 °C
	Time within 5°C of actual peak temperature (t _p)	10-30 seconds	20-40 seconds
	Ramp down rate	6°C/second max.	6°C/second max.
	Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

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Specification Revision History

Rev.	Date	Changed Items	Pre-Changed Content	Changed Content
A/1	2014-10-20	First Issue		
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